



- NOTE
1. ALL EXPOSED METALLIZED AREA SHALL BE GOLD PLATED .001 MICRO INCH MIN THK OVER NICKEL PLATED UNLESS OTHERWISE SPECIFIED PURCHASE ORDER.
  2. FLATNESS PERTAINS METALLIZED PAD ONLY.
  3. SEAL RING AND DIE ATTACH PAD ARE NOT GROUND TO A LEAD.

MODIFICATIONS			
CHANGE	DATE	DRAWN	CHECKED/APPROVED

  

NAME	16 LEAD CHIP CARRIER	TOLERANCES:	UNLESS OTHERWISE SPECIFIED
SCALE	1/16		± 1%
MATERIAL	KYOCERA A-440		N.L.T. ± .005
DATE	79-8-24		
DRAWN	W. M. ...	CHECKED	W. M. ...
APPROVED	...	DATE	79-8-24

  

DATE	DRAWN	CHECKED	APPROVED

  

NAME	KYOTO CERAMIC CO., LTD.	DATE	79-8-24
SCALE	1/16	DATE	79-8-24
MATERIAL	KYOCERA A-440	DATE	79-8-24
DATE	79-8-24	DATE	79-8-24
DRAWN	W. M. ...	CHECKED	W. M. ...
APPROVED	...	DATE	79-8-24

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